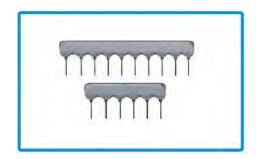
# **Thick Film Resistor Networks**

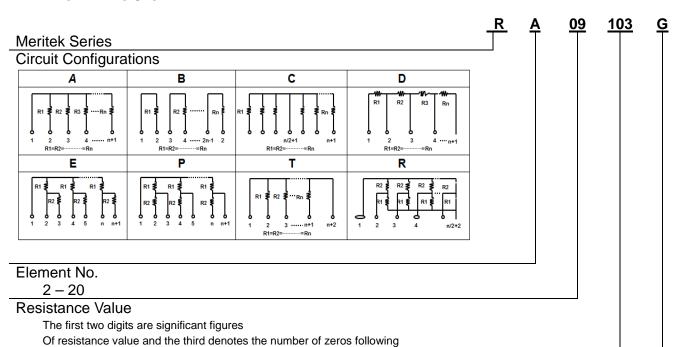
**MERITEK** 

#### Feature

- Wide resistance range: 2291 to  $1M\Omega$  (1  $0\Omega$  3.3  $M\Omega$  available)
- Miniature package with maximum sealed heights 0.2"(5.08mm)
- Highly stable thick film products
- Products protected by tough epoxy conformal coating
- Reduces total assembly cost
- Mixed value resistances available



## PART NUMBERING SYSTEM



CODE

Value

Resistance Tolerance						
	CODE	F	G	J		
	Tolerance	± 1%	± 2%	± 5%		

472

 $4.7 \text{K}\Omega$ 

223

 $22K\Omega$ 

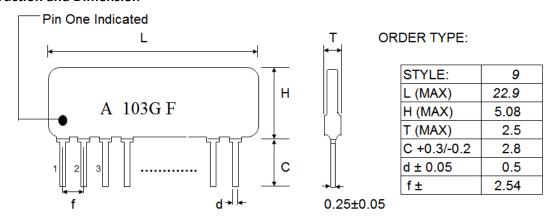
104

 $100 \text{K}\Omega$ 

### **Construction and Dimension**

331

 $330\Omega$ 



# **Thick Film Resistor Networks**



Item	Requirement	Test Methods
Resistance to soldering heat	$\Delta R \le \pm (0.5\% + 0.05\Omega)$	With 350±5°C, for 3 seconds
Solderability	Over 95% of termination must be covered with new solder.	After immersing flus, dip in the 260°C Max. solder bath for 3±0.5 sec.
Terminal Strength (Tensile Strength)	$\Delta R \le \pm (0.5\% + 0.05\Omega)$ No mechanical damage.	Tensile: 1Kg for 30 Sec. Bending: 500g for 2 times
Exterior	No mechanical defect.	Visual
Size	Within specification	Calipers

# **Mechanical Characteristics**

# **Electrical Characteristics**

Item	Requirement	Test Methods
Temperature Coefficient (ppm / °C)	R<50Ω , ±250 PPM/°C 50Ω≤R<2.2MΩ , ±100PPM/°C R≥2.2MΩ , ±250PPM/°C	TCR (PPM/°C)= $\frac{R2R1}{R1}$ X $\frac{1}{T2-T1}$ T1= 25°C T2= Test Temperature (-55°C ~ +125°C) R1: Resistance at Temp. T1 R2: Resistance at Temp. T2
Short-Time Overload	$\Delta R \le \pm (0.5\% + 0.05\Omega)$	2.5X Rated Voltage for 5 Sec. (200V max.) Measure resistance after 30 minutes.